CRMGTL0301A

N-Channel 30V, 1.4mΩ Typ. Power MOSFET

Description

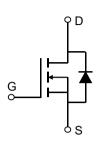
Features

• 30V, 160A

$$R_{DS(ON)}$$
 Typ = 1.4m Ω @ V_{GS} = 10 V

$$R_{DS(ON)}$$
 Typ = 2.3m Ω @ V_{GS} = 4.5V

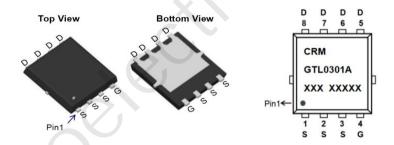
- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!





Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMGTL0301A	CRMGTL0301A	PDFN5x6-8L	TAPING	13"	5000	50000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		30	V
V _{GS}	Gate-to-Source Voltage		±20	V
,	Continuous Drain Current	T _C = 25°C	160	Α
I _D		T _C = 100°C	96	Α
I _{DM}	Pulsed Drain Current ⁽¹⁾		640	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		400	mJ
P_{D}	Power Dissipation	T _C = 25°C	89	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		1.4	°C/W
T_J,T_STG	Junction & Storage Temperature Range		-55 to 150	°C



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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 30V, V_{GS} = 0V$	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2	1.6	2.4	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 10V, I_D = 20A$	-	1.4	2	mΩ
		$V_{GS} = 4.5V, I_D = 15A$	-	2.3	3	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-(6424	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 15V,$ f = 1MHz	X-\	841	-	pF
C_{rss}	Reverse Transfer Capacitance	1 - 1101112		445	-	pF
Q_g	Total Gate Charge		U -	108	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 15V, I_{D} = 30A$	-	20	-	nC
Q_{gd}	Gate Drain("Miller") Charge	VDS = 10 V, 10 = 0071	-	20	-	nC
Switchin	g Characteristics					
$t_{d(on)}$	Turn-On DelayTime	.rO	-	13	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 15V$	-	29	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 30A$, $R_{GEN} = 3\Omega$	-	85	-	ns
t_f	Turn-Off Fall Time		-	50	-	ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
Is	Maximum Continuous Drain to Source Diode Forward Current		-	-	160	Α
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	640	Α
V _{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 20A$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 - 201 dildt - 1001/	-	28	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 20A$, di/dt = 100A/us	-	16	-	nC
	T 1					

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =15V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =40A

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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Test Circuit

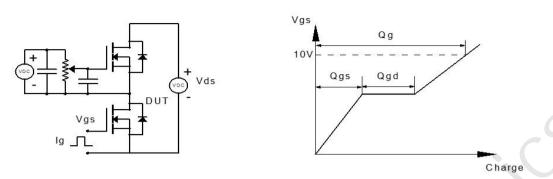


Figure 1: Gate Charge Test Circuit & Waveform

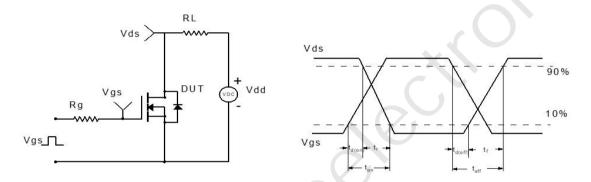


Figure 2: Resistive Switching Test Circuit & Waveform

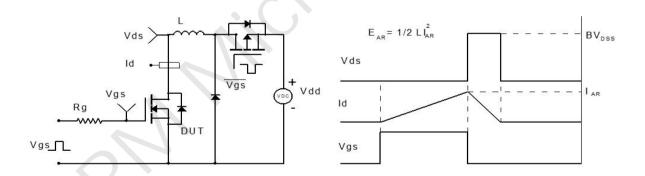


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

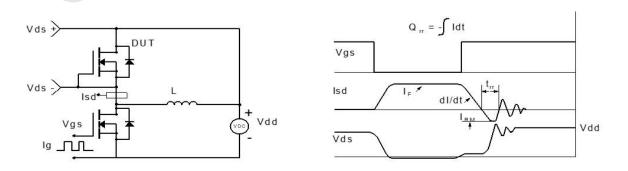
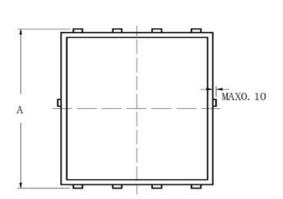


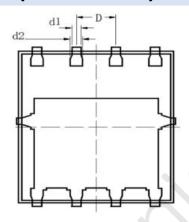
Figure 4: Diode Recovery Test Circuit & Waveform

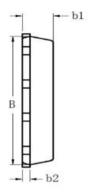
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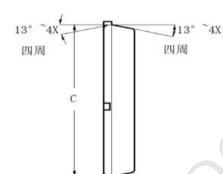
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Package Mechanical Data(PDFN5x6-8L)









COMMON IN DIMENSION (MM)						
PKG	PDFN 5×6-8L					
Symbol	MIN	MON	MAX			
A	6.000	6.100	6.200			
В	4.875	4.900	4.925			
b1	0. 975	1. 000	1. 025			
b2	0.246	0.254	0.262			
C	5.775	5.800	5.825			
D	1. 270					
d1	0.300					
d2	0.400					

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